## STPS0530Z

## Schottky rectifiers

## Main product characteristics

I <sub>F(AV)</sub>	0.5 A
V <sub>RRM</sub>	30 V
V <sub>F</sub> (max)	0.33 V

### Features and benefits

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching

## Description

Table 1.

Single Schottky rectifier suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in SOD-123, this device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications. Due to the small size of the package this device fits GSM and PCMCIA requirements.

Absolute ratings (limiting values)

K
SOD-123 STPS0503Z

### Order code

Order code	Marking	
STPS0503Z	Z53	

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage	30	V	
I <sub>F(RMS)</sub>	RMS forward current	2	А	
I <sub>F(AV)</sub>	Average forward current $\delta = 0.5$	$T_a = 55^\circ C$	0.5	А
I <sub>FSM</sub>	Surge non repetitive forward current t <sub>p</sub> = 10 ms sinusoidal		5.5	А
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	
T <sub>stg</sub>	Storage temperature range	-65 to + 150	°C	
Тj	Maximum operating junction temperature (	150	°C	
TL	Maximum temperature for soldering during	260	°C	

1.  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

## 1 Characteristics

### Table 2.Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>th(j-a)</sub>	Junction to ambient	340 <sup>(1)</sup>	°C/W

1. Copper area on PCB S =  $2.5 \text{ mm}^2$ 

### Table 3. Static electrical characteristics

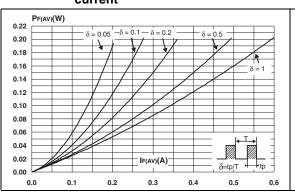
				Val	ue	
Symbol	Parameter	Test conditions		STPS0530Z		Unit
				Тур.	Max.	
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	$T_j = 25^\circ C$	V <sub>R</sub> = 15 V		12	μA
		$T_j = 125^\circ C$		3	5	mA
		$T_j = 25^\circ C$	V <sub>R</sub> = V <sub>RRM</sub>		130	μA
		$T_j = 125^\circ C$		9	21	mA
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	$T_j = 25^\circ C$	I <sub>F</sub> = 0.1 A		0.375	v
		$T_j = 125^\circ C$		0.20	0.22	
		$T_j = 25^\circ C$	l <sub>F</sub> = 0.5 A		0.43	
		$T_j = 125^\circ C$		0.31	0.33	

1. Pulse test: tp = 5 ms,  $\delta$  < 2%

2. Pulse test: tp = 380  $\mu s, \, \delta < 2\%$ 

To evaluate the maximum conduction losses use the following equation: P = 0.23 x  $I_{F(AV)}$  + 0.18  ${I_F}^2_{(RMS)}$ 





#### Figure 1. Conduction losses versus average Figure 2. Average forward current versus current

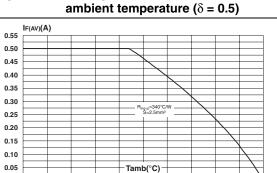
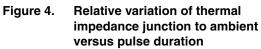


Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

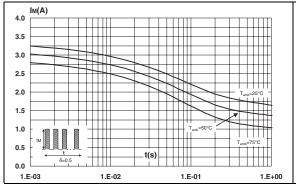


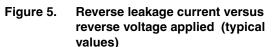
75

100

125

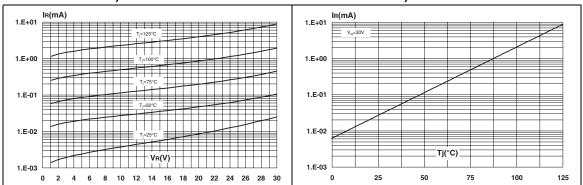
50





Zth(j-a)/Rth(j-a) 1.0E+00 T 1.0E-01 1.0E-02 tp(s) δ=tp/T 1.0E-03 1.E-03 1.E-02 1.E-01 1.E+00 1.E+01 1.E+02

Figure 6. Reverse leakage current versus junction temperature (typical values)



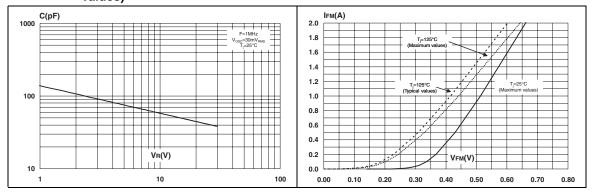
0.00

0

25

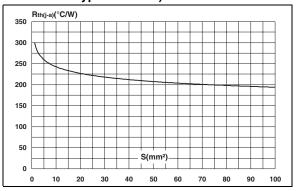
57

# Figure 7. Junction capacitance versus reverse voltage applied (typical values)



## Figure 8. Forward voltage drop versus forward current

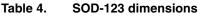
Figure 9. Thermal resistance junction to ambient versus copper surface under each lead (epoxy printed circuit board FR4, Cu = 35 μm, typical values)





## 2 Package information

- Epoxy meets UL94, V0.
- Band indicates cathode.



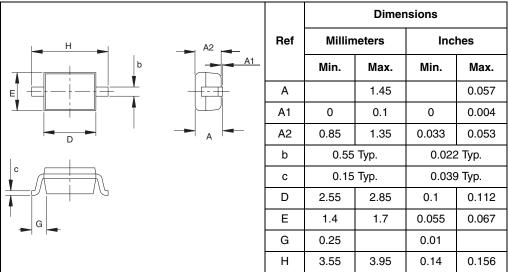
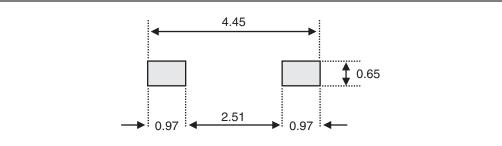


Figure 10. Footprint (in millimeters)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



## **3** Ordering information

Ordering type Marking		Package	Weight	Base qty	Delivery mode
STPS0530Z Z53		SOD-123	0.01 g	3000	Tape & reel

## 4 Revision history

Date	Revision	Changes
Mar-2003	1A	Initial release.
17-Oct-2006 2		Reformated to current standards. Updated maximum junction temperatures to 150° C and updated package illustration to show cathode bar on page 1

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